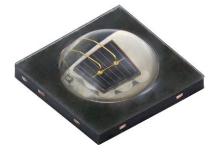
VSMY98575ADS

Vishay Semiconductors

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



www.vishay.com

DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY98575ADS is an infrared, 850 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

FEATURES

- Package type: surface-mount
- Double stack technology
- Package form: power QFN
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 1.51
- Peak wavelength: $\lambda_p = 850 \text{ nm}$
- Zener diode for ESD protection up to 2 kV
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\phi = \pm 75^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R_{thJP} = 9 K/W
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Infrared illumination for CMOS cameras (CCTV, 3D gaming)
- Machine vision

PRODUCT SUMMARY					
COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)	
VSMY98575ADS	320	± 75	850	14	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY98575ADS	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens		

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	1	A	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	2	A	
Surge forward current	t _p = 100 μs	I _{FSM}	5	А	
Power dissipation		Pv	3.5	W	
Junction temperature		Tj	115	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-55 to +100	°C	
Soldering temperature	According to Fig. 7, J-STD-20	T _{sd}	260	°C	
Thermal resistance junction / pin	JESD 51	R _{thJP}	9	K/W	

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RoHS

COMPLIANT

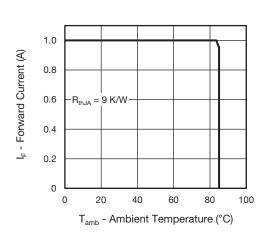
<u>GREEN</u>

(5-2008)



4.0 3.5 P_V - Power Dissipation (W) 3.0 2.5 2.0 = 9 K/W 1.5 1.0 0.5 0 0 20 40 60 80 100 T_{amb} - Ambient Temperature (°C)

Fig. 1 - Power Dissipation Limit vs. Ambient Temperature



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Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 1 A, t _p = 20 ms	V _F	-	3.1	3.5	V
Temperature coefficient of V_F	I _F = 1 A	TK _{VF}	-	-3	-	mV/K
Reverse current	$V_{R} = 5 V$	I _R	-	-	10	μA
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	130	-	pF
Radiant intensity	I _F = 1 A, t _p = 20 ms	l _e	160	320	-	mW/sr
Radiant power	I _F = 1 A, t _p = 20 ms	фе	-	1270	-	mW
Temperature coefficient of ϕ_{e}	I _F = 1 A, t _p = 20 ms	TH_{qe}	-	-0.3	-	%/K
Angle of half intensity		φ	-	± 75	-	deg
Peak wavelength	I _F = 1 A	λρ	830	850	870	nm
Spectral bandwidth	I _F = 1 A	Δλ	-	35	-	nm
Rise time	I _F = 1 A	t _r	-	14	-	ns
Fall time	I _F = 1 A	t _f	-	17	-	ns

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

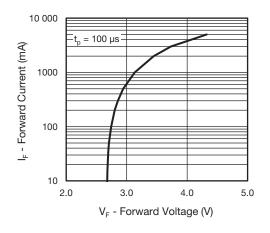


Fig. 3 - Forward Current vs. Forward Voltage

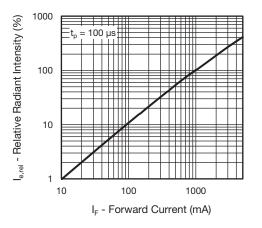


Fig. 4 - Relative Radiant Intensity vs. Forward Current

2

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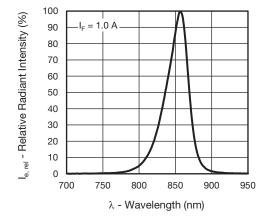
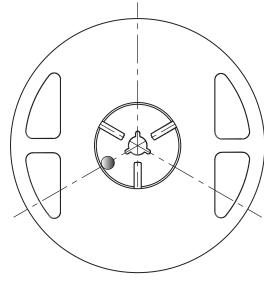
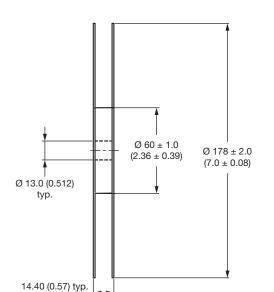


Fig. 5 - Relative Radiant Intensity vs. Wavelength

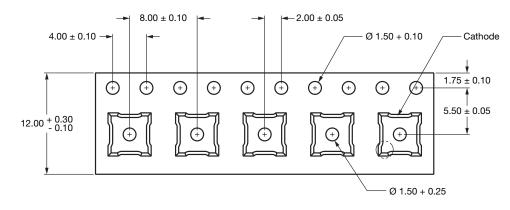






Notes

- Empty component pockets sealed with top cover tape
- 7 inch reel 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications •



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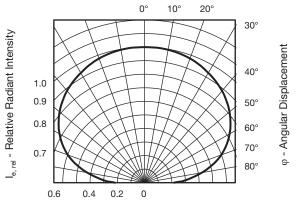


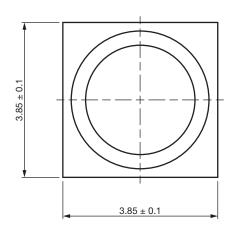
Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

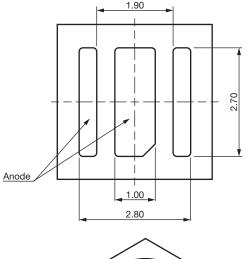


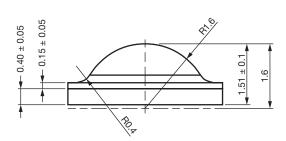
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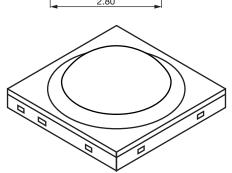


PACKAGE DIMENSIONS in millimeters





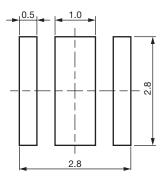




Notes

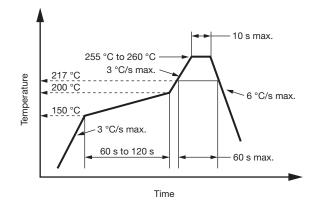
- Tolerance is ± 0.10 mm (0.004") unless otherwise noted
- Specifications are subject to change without notice

SOLDER PAD PROPOSAL



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SOLDER PROFILE



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Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



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